

Electronic Patent Application Fee Transmittal

Application Number:	10751428
Filing Date:	06-Jan-2004
Title of Invention:	ELECTROPLATING PROCESS OF ELECTROPLATING AN ELECTRICALLY CONDUCTIVE SUBSTRATE
First Named Inventor/Applicant Name:	Honchin En
Filer:	Howard Leonard Bernstein/Elizabeth DiNorma
Attorney Docket Number:	Q78819

Filed as Large Entity

Utility under 35 USC 111(a) Filing Fees

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Utility Appl issue fee	1501	1	1510	1510
Publ. Fee- early, voluntary, or normal	1504	1	300	300

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Extension-of-Time:				
Miscellaneous:				
Total in USD (\$)				1810